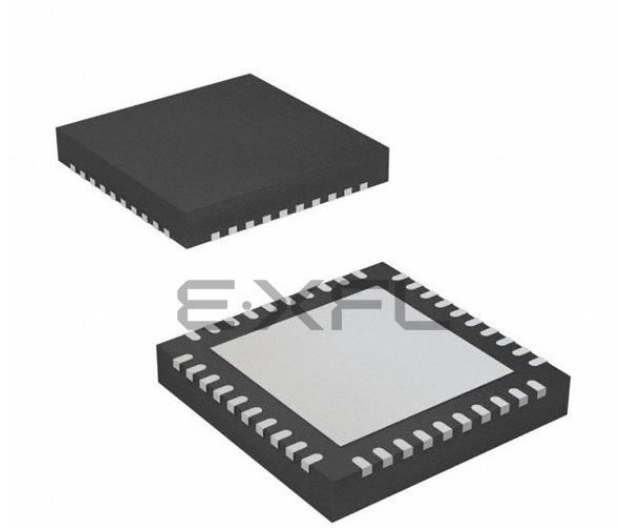
Microchip Technology - PIC32MM0064GPL036T-I/MV Datasheet



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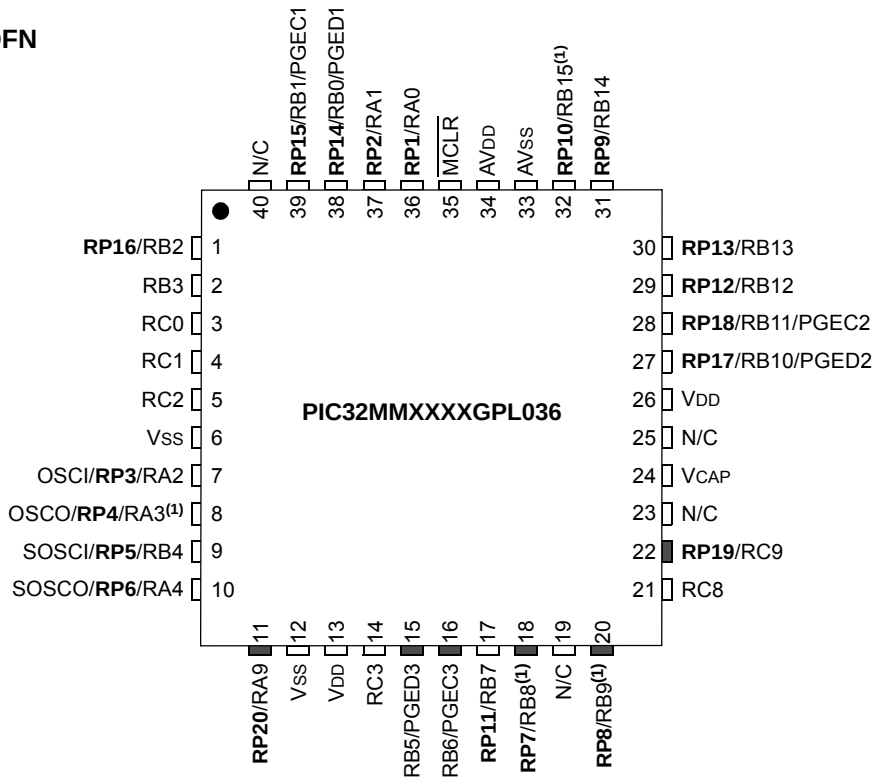
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	MIPS32® microAptiv™
Core Size	32-Bit Single-Core
Speed	25MHz
Connectivity	IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, I²S, POR, PWM, WDT
Number of I/O	29
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 14x10/12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UFQFN Exposed Pad
Supplier Device Package	40-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mm0064gpl036t-i-mv

Pin Diagrams (Continued)

40-Pin UQFN



Legend: Shaded pins are up to 5V tolerant.

Note 1: Pin has an increased current drive strength. Refer to **Section 26.0 "Electrical Characteristics"** for details.

TABLE 7: COMPLETE PIN FUNCTION DESCRIPTIONS FOR 40-PIN UQFN DEVICES

Pin	Function	Pin	Function
1	AN4/C1INB/**RP16**/RB2	21	RC8
2	AN11/C1INA/RB3	22	**RP19**/RC9
3	AN12/RC0	23	N/C
4	AN13/RC1	24	VCAP
5	RC2	25	N/C
6	VSS	26	VDD
7	OSC1/CLKI/AN5/**RP3**/OCM1C/RA2	27	PGED2/TDO/**RP17**/RB10
8	OSC2/CLKO/AN6/**RP4**/OCM1D/RA3(1)	28	PGEC2/TDI/**RP18**/RB11
9	SOSCI/**RP5**/RB4	29	AN7/LVDIN/**RP12**/RB12
10	SOSCO/SCLKI/**RP6**/PWRLCLK/RA4	30	AN8/**RP13**/RB13
11	**RP20**/RA9	31	CDAC1/AN9/**RP9**/RTCC/U1TX/SDI1/C1OUT/INT1/RB14
12	VSS	32	AN10/REFCLKO/**RP10**/U1RX/$\overline{SS1}$/FSYNC1/INT0/RB15(1)
13	VDD	33	AVSS
14	RC3	34	AVDD
15	PGED3/RB5	35	$\overline{MCLR}$
16	PGEC3/RB6	36	VREF+/AN0/**RP1**/OCM1E/INT3/RA0
17	**RP11**/RB7	37	VREF-/AN1/**RP2**/OCM1F/RA1
18	TCK/**RP7**/$\overline{U1CTS}$/SCK1/OCM1A/RB8(1)	38	PGED1/AN2/C1IND/C2INB/**RP14**/RB0
19	N/C	39	PGEC1/AN3/C1INC/C2INA/**RP15**/RB1
20	TMS/REFCLKI/**RP8**/T1CK/T1G/$\overline{U1RTS}$/U1BCLK/SDO1/C2OUT/OCM1B/INT2/RB9(1)	40	N/C

Note 1: Pin has an increased current drive strength.

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An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

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REGISTER 3-3: CONFIG3: CONFIGURATION REGISTER 3; CP0 REGISTER 16, SELECT 3

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	r-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	R-0	R-1	R-0	R-0	R-0	R-1	R-1
	—	IPLW<1:0>		MMAR<2:0>			MCU	ISAONEXC
15:8	R-0	R-1	R-1	R-1	U-0	U-0	U-0	R-0
	ISA<1:0>		ULRI	RXI	—	—	—	ITL
7:0	U-0	R-1	R-1	R-0	R-1	U-0	U-0	R-0
	—	VEIC	VINT	SP	CDMM	—	—	TL

Legend:	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **Reserved:** This bit is hardwired as '0'

bit 30-23 **Unimplemented:** Read as '0'

bit 22-21 **IPLW<1:0>:** Width of the Status IPL and Cause RIPL bits
01 = IPL and RIPL bits are 8 bits in width

bit 20-18 **MMAR<2:0>:** microMIPS™ Architecture Revision Level bits
000 = Release 1

bit 17 **MCU:** MIPS® MCU ASE Implemented bit
1 = MCU ASE is implemented

bit 16 **ISAONEXC:** ISA on Exception bit
1 = microMIPS is used on entrance to an exception vector

bit 15-14 **ISA<1:0>:** Instruction Set Availability bits
01 = Only microMIPS is implemented

bit 13 **ULRI:** UserLocal Register Implemented bit
1 = UserLocal Coprocessor 0 register is implemented

bit 12 **RXI:** RIE and XIE Implemented in PageGrain bit
1 = RIE and XIE bits are implemented

bit 11-9 **Unimplemented:** Read as '0'

bit 8 **ITL:** Indicates that iFlowtrace™ Hardware is Present bit
0 = The iFlowtrace hardware is not implemented in the core

bit 7 **Unimplemented:** Read as '0'

bit 6 **VEIC:** External Vector Interrupt Controller bit
1 = Support for an external interrupt controller is implemented.

bit 5 **VINT:** Vector Interrupt bit
1 = Vector interrupts are implemented

bit 4 **SP:** Small Page bit
0 = 4-Kbyte page size

bit 3 **CDMM:** Common Device Memory Map bit
1 = CDMM is implemented

bit 2-1 **Unimplemented:** Read as '0'

bit 0 **TL:** Trace Logic bit
0 = Trace logic is not implemented

10.1 Timer1 Control Register

TABLE 10-1: TIMER1 REGISTER MAP

Virtual Address (BF80_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
8000	T1CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	TWDIS	TWIP	—	TECS<1:0>		TGATE	—	TCKPS<1:0>		—	TSYNC	TCS	—	0000
8010	TMR1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	TMR1<15:0>																0000
8020	PR1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	PR1<15:0>																FFFF

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively.

REGISTER 12-2: CCPxCON2: CAPTURE/COMPARE/PWMx CONTROL 2 REGISTER (CONTINUED)

bit 14 **ASDGM:** CCPx Auto-Shutdown Gate Mode Enable bit
1 = Waits until the next Time Base Reset or rollover for shutdown to occur
0 = Shutdown event occurs immediately

bit 13 **Unimplemented:** Read as '0'

bit 12 **SSDG:** CCPx Software Shutdown/Gate Control bit
1 = Manually forces auto-shutdown, timer clock gate or input capture signal gate event (setting the ASDGM bit still applies)
0 = Normal module operation

bit 11-8 **Unimplemented:** Read as '0'

bit 7-0 **ASDG<7:0>:** CCPx Auto-Shutdown/Gating Source Enable bits
1xxx xxxx = Auto-shutdown is controlled by the OCFB pin (remappable)
x1xx xxxx = Auto-shutdown is controlled by the OCFA pin (remappable)
xx1x xxxx = Auto-shutdown is controlled by CLC1 for MCCP1/SCCP2 and by CLC2 for SCCP3
xxx1 xxxx = Auto-shutdown is controlled by the SCCP2 output for MCCP1 and by MCCP1 for SCCP2/SCCP3
xxxx 1xxx = Auto-shutdown is controlled by the SCCP3 output for MCCP1/SCCP2 and by SCCP2 for SCCP3
xxxx x1xx = Reserved
xxxx xx1x = Auto-shutdown is controlled by Comparator 2
xxxx xxx1 = Auto-shutdown is controlled by Comparator 1

Note 1: OCFEN through OCBEN (bits<29:25>) are implemented in MCCP modules only.

REGISTER 13-1: SPIxCON: SPIx CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FRMCNT<2:0>		
23:16	R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
	MCLKSEL(1)	—	—	—	—	—	SPIFE	ENHBUF(1)
15:8	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ON	—	SIDL	DISSDO(4)	MODE32	MODE16	SMP	CKE(2)
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SSEN	CKP(3)	MSTEN	DISSDI(4)	STXISEL<1:0>		SRXISEL<1:0>	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **FRMEN:** Framed SPI Support bit
- 1 = Framed SPI support is enabled ($\overline{SSx}$ pin is used as the FSYNC1 input/output)
- 0 = Framed SPI support is disabled

bit 30 **FRMSYNC:** Frame Sync Pulse Direction Control on $\overline{SSx}$ Pin bit (Framed SPI mode only)
- 1 = Frame sync pulse input (Slave mode)
- 0 = Frame sync pulse output (Master mode)

bit 29 **FRMPOL:** Frame Sync Polarity bit (Framed SPI mode only)
- 1 = Frame pulse is active-high
- 0 = Frame pulse is active-low

bit 28 **MSSEN:** Master Mode Slave Select Enable bit
- 1 = Slave select SPI support is enabled; the $\overline{SSx}$ pin is automatically driven during transmission in Master mode, polarity is determined by the FRMPOL bit
- 0 = Slave select SPI support is disabled

bit 27 **FRMSYPW:** Frame Sync Pulse-Width bit
- 1 = Frame sync pulse is one character wide
- 0 = Frame sync pulse is one clock wide

bit 26-24 **FRMCNT<2:0>:** Frame Sync Pulse Counter bits

Controls the number of data characters transmitted per pulse. This bit is only valid in Framed mode.
- 111 = Reserved
- 110 = Reserved
- 101 = Generates a frame sync pulse on every 32 data characters
- 100 = Generates a frame sync pulse on every 16 data characters
- 011 = Generates a frame sync pulse on every 8 data characters
- 010 = Generates a frame sync pulse on every 4 data characters
- 001 = Generates a frame sync pulse on every 2 data characters
- 000 = Generates a frame sync pulse on every data character

Note 1: These bits can only be written when the ON bit = 0. Refer to **Section 26.0 "Electrical Characteristics"** for maximum clock frequency requirements.

2: This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).

3: When AUDEN = 1, the SPI/I^2S module functions as if the CKP bit is equal to '1', regardless of the actual value of the CKP bit.

4: These bits are present for legacy compatibility and are superseded by PPS functionality on these devices (see **Section 9.8 "Peripheral Pin Select (PPS)"** for more information).

REGISTER 16-5: AD1CHS: ADC INPUT SELECT REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	CH0NA<2:0>			CH0SA<4:0>(1)				

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 **Unimplemented:** Read as '0'

bit 7-5 **CH0NA<2:0>:** Negative Input Select bits
111-001 = Reserved
000 = Negative input is AVSS

bit 4-0 **CH0SA<4:0>:** Positive Input Select bits(1)
11111 = Reserved
11110 = Positive input is AVDD
11101 = Positive input is AVSS
11100 = Positive input is Band Gap Reference (VBG)
11011-01110 = Reserved
01101 = Positive input is AN13(2,3)
01100 = Positive input is AN12(2,3)
01011 = Positive input is AN11(2)
01010 = Positive input is AN10
01001 = Positive input is AN9
01000 = Positive input is AN8
00111 = Positive input is AN7
00110 = Positive input is AN6
00101 = Positive input is AN5
00100 = Positive input is AN4
00011 = Positive input is AN3
00010 = Positive input is AN2
00001 = Positive input is AN1
00000 = Positive input is AN0

Note 1: The CH0SA<4:0> positive input selection is only used when CSCNA (AD1CON2<10>) = 0 and ASEN (AD1CON5<15>) = 0. The AD1CSS bits specify the positive inputs when CSCNA = 1 or ASEN = 1.

2: This option is not implemented in the 20-pin devices.

3: This option is not implemented in the 28-pin devices.

NOTES:

TABLE 17-1: CRC REGISTER MAP

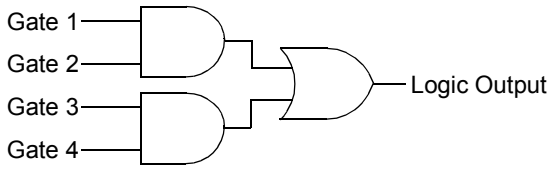
Virtual Address (BF80_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
0A00	CRCCON	31:16	—	—	—	DWIDTH<4:0>					—	—	—	PLEN<4:0>					0000
		15:0	ON	—	SIDL	VWORD<4:0>					CRCFUL	CRCMPT	CRCISEL	CRCGO	LENDIAN	MOD	—	—	0000
0A10	CRCXOR	31:16	X<31:16>																0000
		15:0	X<15:1>															—	0000
0A20	CRCDAT	31:16	CRCDAT<31:0>																0000
		15:0																	0000
0A30	CRCWDAT	31:16	CRCWDAT<31:0>																0000
		15:0																	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively.

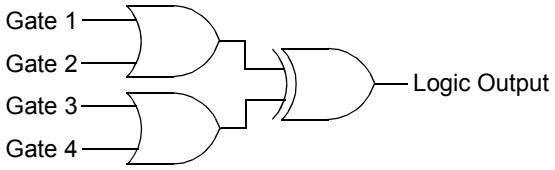
FIGURE 18-2: CLCx LOGIC FUNCTION COMBINATORIAL OPTIONS

AND – OR



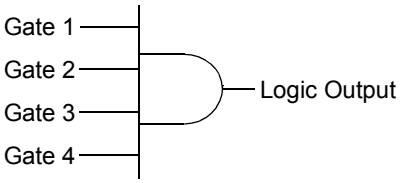
MODE<2:0> = 000

OR – XOR



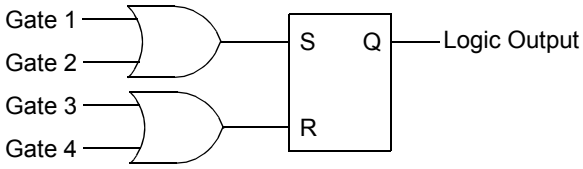
MODE<2:0> = 001

4-Input AND



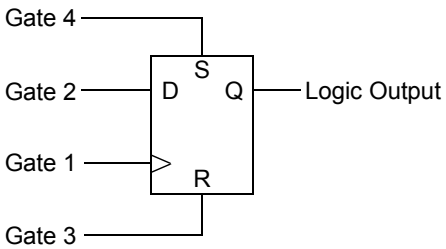
MODE<2:0> = 010

S-R Latch



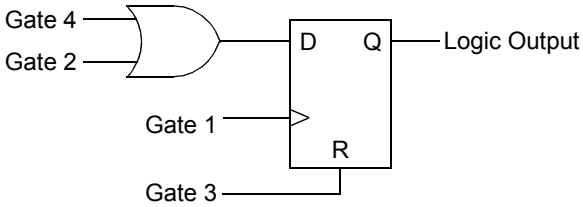
MODE<2:0> = 011

1-Input D Flip-Flop with S and R



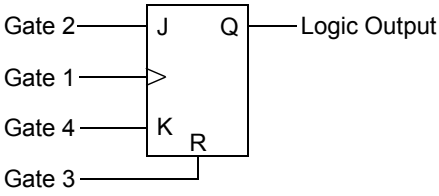
MODE<2:0> = 100

2-Input D Flip-Flop with R



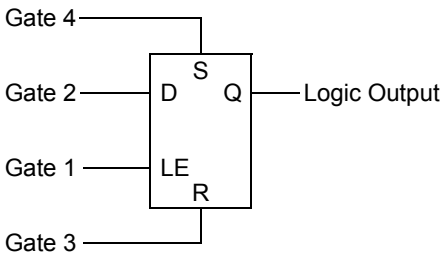
MODE<2:0> = 101

J-K Flip-Flop with R



MODE<2:0> = 110

1-Input Transparent Latch with S and R



MODE<2:0> = 111

REGISTER 18-1: CLCxCON: CLCx CONTROL REGISTER (CONTINUED)

bit 5 **LCPOL:** CLCx Output Polarity Control bit
1 = The output of the module is inverted
0 = The output of the module is not inverted

bit 4-3 **Unimplemented:** Read as '0'

bit 2-0 **MODE<2:0>:** CLCx Mode bits
111 = Cell is a 1-input transparent latch with S and R
110 = Cell is a JK flip-flop with R
101 = Cell is a 2-input D flip-flop with R
100 = Cell is a 1-input D flip-flop with S and R
011 = Cell is an SR latch
010 = Cell is a 4-input AND
001 = Cell is an OR-XOR
000 = Cell is a AND-OR

Note 1: The INTP and INTN bits should not be set at the same time for proper interrupt functionality.

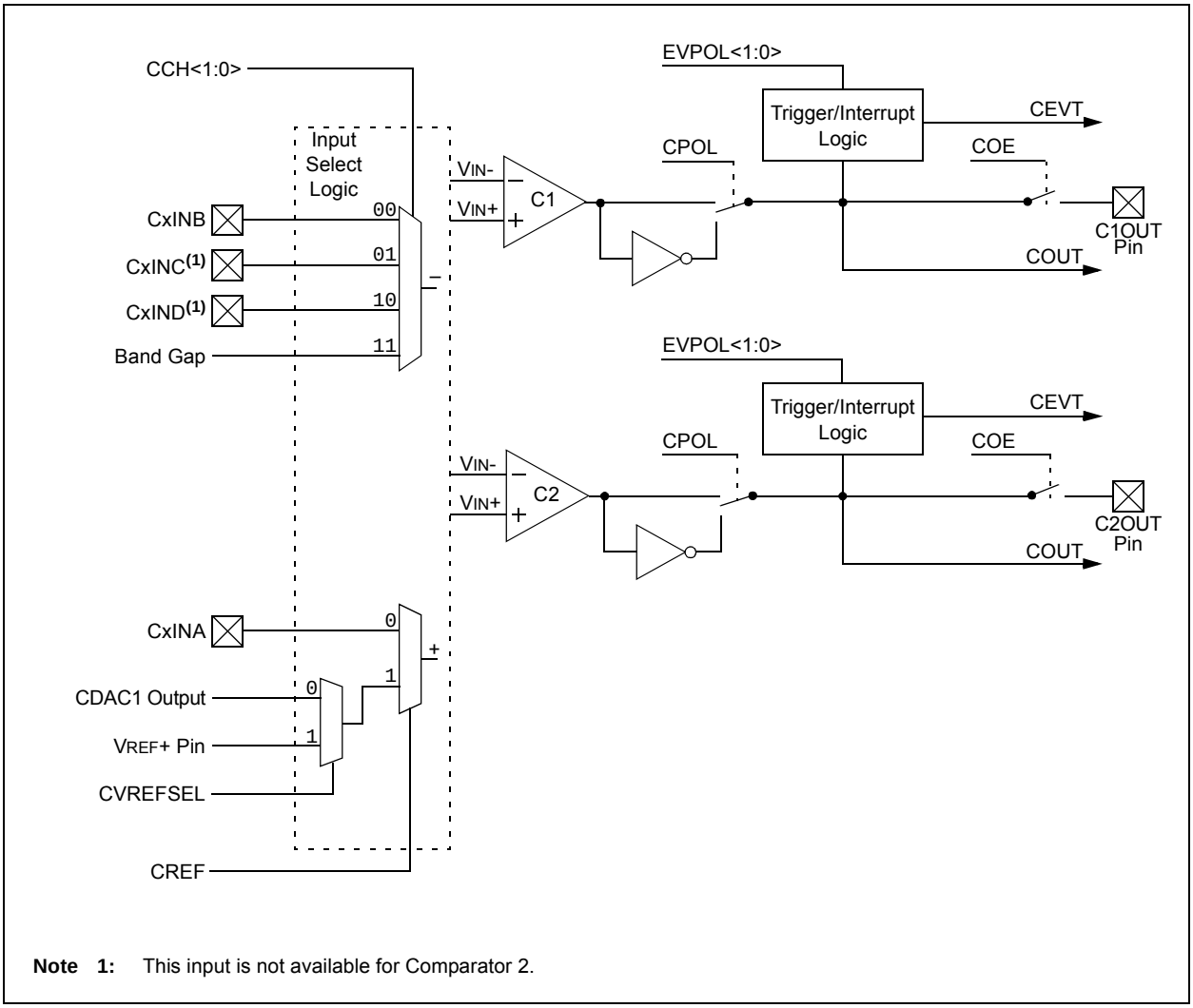
19.0 COMPARATOR

Note: This data sheet summarizes the features of the PIC32MM0064GPL036 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 19. "Comparator"** (DS60001110) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32). The information in this data sheet supersedes the information in the FRM.

The comparator module provides two dual input comparators. The inputs to the comparator can be configured to use any one of five external analog inputs (CxINA, CxINB, CxINC, CxIND and VREF+). The comparator outputs may be directly connected to the CxOUT pins. When the respective COE bit equals '1', the I/O pad logic makes the unsynchronized output of the comparator available on the pin.

A simplified block diagram of the module is shown in Figure 19-1. Each comparator has its own control register, CMxCON (Register 19-2), for enabling and configuring its operation. The output and event status of two comparators is provided in the CMSTAT register (Register 19-1).

FIGURE 19-1: DUAL COMPARATOR MODULE BLOCK DIAGRAM



Note 1: This input is not available for Comparator 2.

20.0 CONTROL DIGITAL-TO-ANALOG CONVERTER (CDAC)

Note: This data sheet summarizes the features of the PIC32MM0064GPL036 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 45. "Control Digital-to-Analog Converter (CDAC)"** (DS60001327) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32). The information in this data sheet supersedes the information in the FRM.

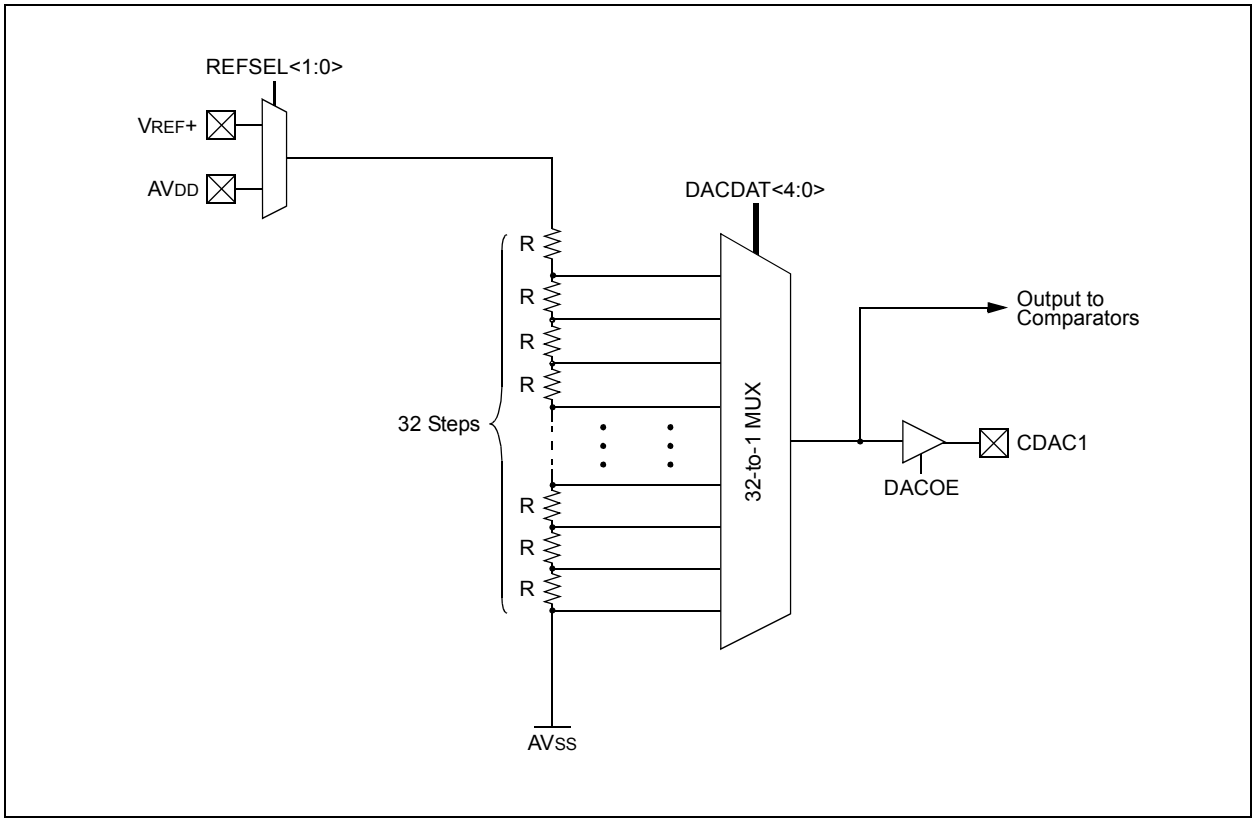
The Control Digital-to-Analog Converter (CDAC) generates analog voltage corresponding to the digital input.

The CDAC has the following features:

- 32 Output Levels are Available
- Internally Connected to Comparators to Conserve Device Pins
- Output can be Connected to a Pin

A block diagram of the CDAC module is illustrated in Figure 20-1.

FIGURE 20-1: CDAC BLOCK DIAGRAM



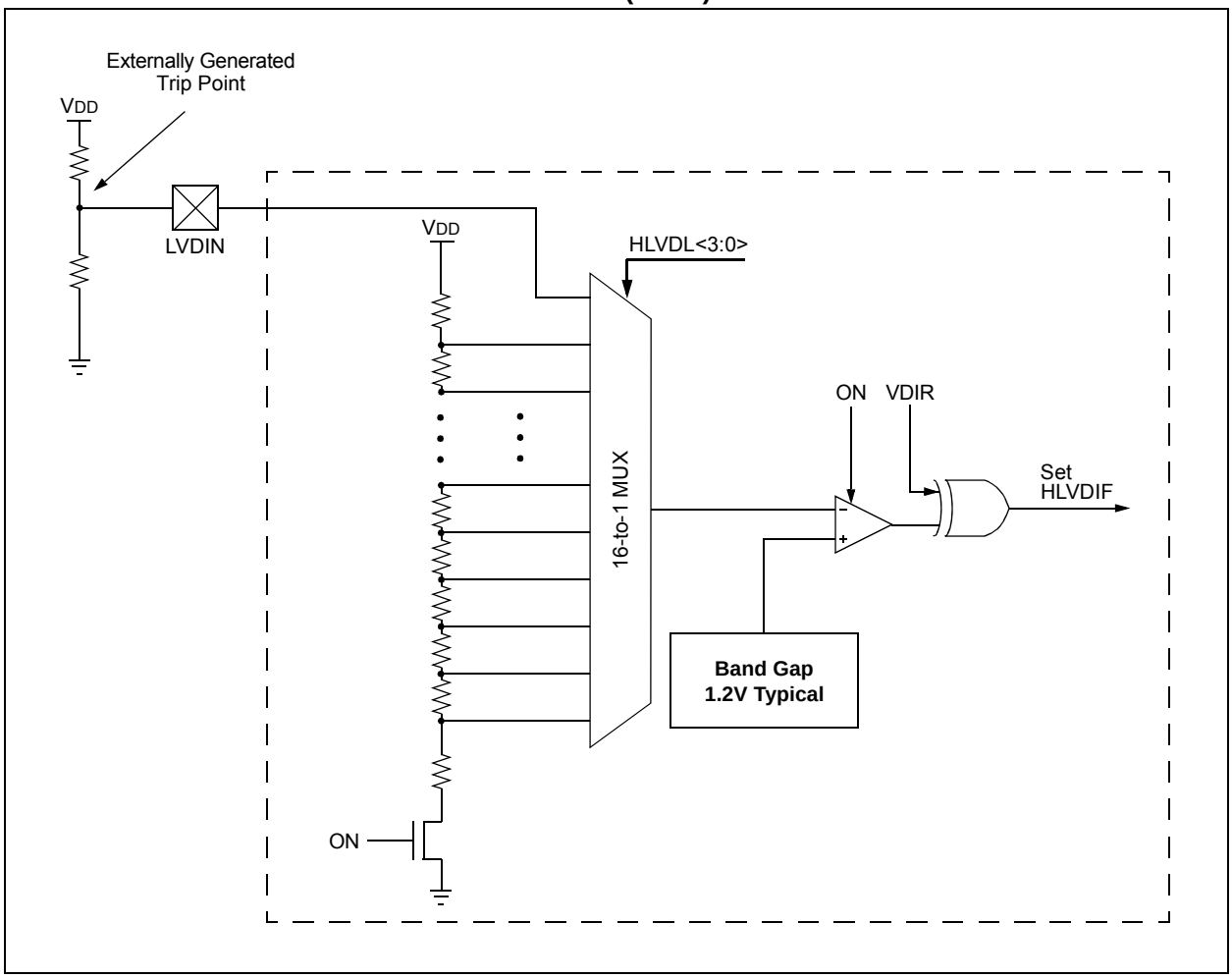
21.0 HIGH/LOW-VOLTAGE DETECT (HLVD)

The High/Low-Voltage Detect (HLVD) module is a programmable circuit that allows the user to specify both the device voltage trip point and the direction of change.

An interrupt flag is set if the device experiences an excursion past the trip point in the direction of change. If the interrupt is enabled, the program execution will branch to the interrupt vector address and the software can then respond to the interrupt.

The HLVD Control register (see Register 21-1) completely controls the operation of the HLVD module. This allows the circuitry to be “turned off” by the user under software control, which minimizes the current consumption for the device.

FIGURE 21-1: HIGH/LOW-VOLTAGE DETECT (HLVD) MODULE BLOCK DIAGRAM



REGISTER 23-10: ANCFG: BAND GAP CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	U-0	R/W-0, HS, HC	R/W-0, HS, HC	U-0
	—	—	—	—	—	VBGADC	VBGCMP	—

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-3 **Unimplemented:** Read as '0'

bit 2 **VBGADC:** ADC Band Gap Enable bit
1 = ADC band gap is enabled
0 = ADC band gap is disabled

bit 1 **VBGCMP:** Comparator Band Gap Enable bit
1 = Comparator band gap is enabled
0 = Comparator band gap is disabled

bit 0 **Unimplemented:** Read as '0'

TABLE 26-6: POWER-DOWN CURRENT (I_{PD})(2)

Parameter No.	Typical(1)	Max	Units	Operating Temperature	VDD	Conditions
DC60	134	198	µA	-40°C	2.0V	Sleep with active main voltage regulator (VREGS (PWRCON<0>) = 1, RETEN (PWRCON<1>) =0)
	136	208	µA	+25°C		
	141	217	µA	+85°C		
	139	209	µA	-40°C	3.3V	
	141	217	µA	+25°C		
	143	231	µA	+85°C		
DC61	4.3	11.7	µA	-40°C	2.0V	Sleep with main voltage regulator in Standby mode (VREGS (PWRCON<0>) = 0, RETEN (PWRCON<1>) = 0)
	5.1	15.6	µA	+25°C		
	11.4	34.3	µA	+85°C		
	6.1	16.8	µA	-40°C	3.3V	
	6.9	20.1	µA	+25°C		
	12.7	36.0	µA	+85°C		
DC62	2.3	—	µA	-40°C	2.0V	Sleep with enabled retention voltage regulator (VREGS (PWRCON<0>) = 1, RETEN (PWRCON<1>) = 1, RETVR (FPOR<2>) = 0)
	2.7	—	µA	+25°C		
	5.2	—	µA	+85°C		
	2.3	—	µA	-40°C	3.3V	
	2.7	—	µA	+25°C		
	5.4	—	µA	+85°C		
DC63	0.28	—	µA	-40°C	2.0V	Sleep with enabled retention voltage regulator (VREGS (PWRCON<0>) = 0, RETEN (PWRCON<1>) = 1, RETVR (FPOR<2>) = 0)
	0.44	—	µA	+25°C		
	2.52	—	µA	+85°C		
	0.29	—	µA	-40°C	3.3V	
	0.44	—	µA	+25°C		
	2.62	—	µA	+85°C		

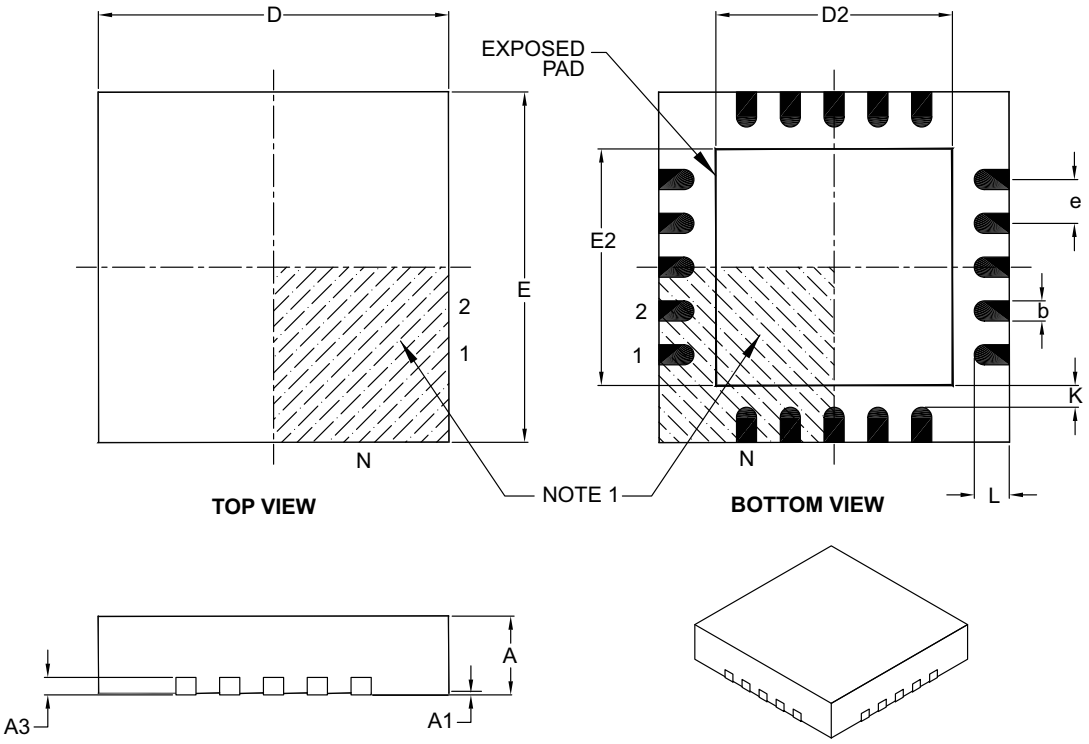
Note 1: Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Base I_{PD} is measured with:

- Oscillator is configured in FRC mode without PLL (FNOSC<2:0> (FOSCSEL<2:0>) = 000)
- OSC2 is configured as I/O in Configuration Words (OSCIOFNC (FOSCSEL<10>) = 1)
- FSCM is disabled (FCKSM<1:0> (FOSCSEL<15:14>) = 00)
- Secondary Oscillator circuits are disabled (SOSCEN (FOSCSEL<6>) = 0 and SOSCSEL (FOSCSEL<12>) = 0)
- Main and low-power BOR circuits are disabled (BOREN<1:0> (FPOR<1:0>) = 00 and LPBOREN (FPOR<3>) = 0)
- Watchdog Timer is disabled (FWDTEN (FWDT<15>) = 0)
- All I/O pins are configured as outputs and driving low
- No peripheral modules are operating or being clocked (defined PMDx bits are all ones)

20-Lead Plastic Quad Flat, No Lead Package (ML) – 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		20	
Pitch	e		0.50 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		4.00 BSC	
Exposed Pad Width	E2	2.60	2.70	2.80
Overall Length	D		4.00 BSC	
Exposed Pad Length	D2	2.60	2.70	2.80
Contact Width	b	0.18	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

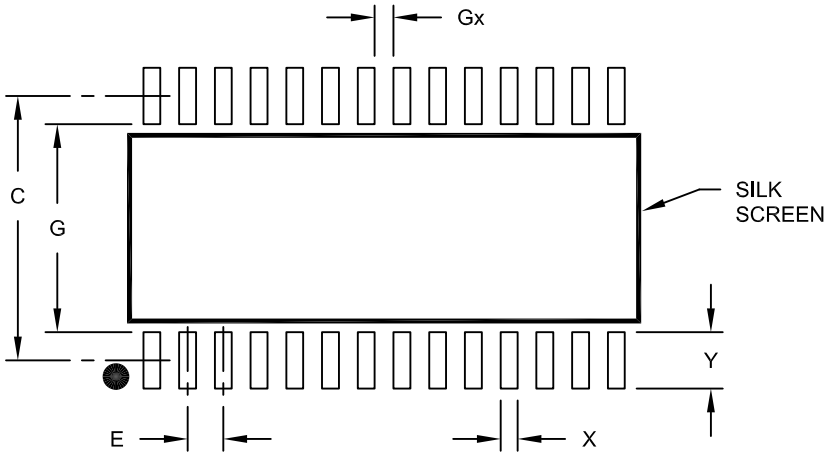
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-126B

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	C		9.40	
Contact Pad Width (X28)	X			0.60
Contact Pad Length (X28)	Y			2.00
Distance Between Pads	Gx	0.67		
Distance Between Pads	G	7.40		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

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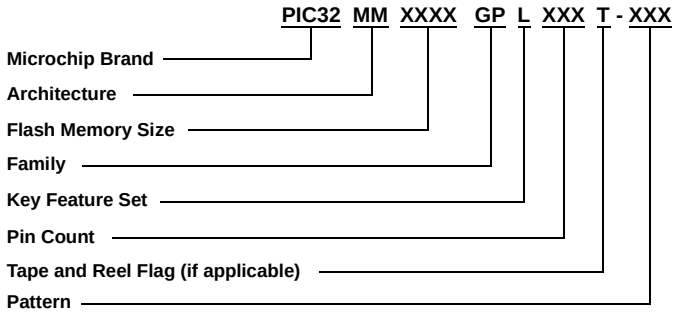
PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.



Architecture	MM	= MIPS32® microAptiv™ UC CPU Core
Flash Memory Size	0016 0032 0064	= 16 Kbytes = 32 Kbytes = 64 Kbytes
Family	GP	= General Purpose Family
Key Feature	L	= Up to 25 MHz operating frequency with basic peripheral set of 2 UART and 2 SPI modules
Pin Count	020 028 036	= 20-pin = 28-pin = 36/40-pin
Pattern	Three-digit QTP, SQTP, Code or Special Requirements (blank otherwise) ES	= Engineering Sample

Example:

PIC32MM0064GPL036-I/M2: PIC32 General Purpose Device with MIPS32® microAptiv™ UC Core, 64-Kbyte Program Memory, 36-Pin Package.